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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Applicant: Kejun Zeng

Docket Number: TI-36531

Serial No.: 10/679,787

Art Unit: 1725

Filed: 10/06/03

Examiner: Jonathan J. Jonson

For: Connection Site Coating Method and Solder Joints

CERTIFICATION OF FACSIMILE TRANSMISSION

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FACSIMILE COVER SHEET

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<input type="checkbox"/> NEW APPLICATION	<input type="checkbox"/> EOT
<input type="checkbox"/> DECLARATION	<input type="checkbox"/> NOTICE OF APPEAL
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<input type="checkbox"/> CONTINUATION APP'N	<input type="checkbox"/> ELECTION
<input type="checkbox"/> DIVISIONAL APP'N	
NAME OF INVENTOR(S): Kejun Zeng	
RECEIPT DATE & SERIAL NO.: Serial No.: 10/679,787	
TITLE OF INVENTION: Connection Site Coating Method and Solder Joints Filing Date: 10/06/03	
TI FILE NO.: TI-36531	DEPOSIT ACCT. NO.: 20-0668
FAXED: 1-16-06 DUE: 1-14-06 ATTY/SECY: ST/jsm/kjv	

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
PATENT APPLICATION

Appl. No. : 10/679,787 Confirmation No. 3730
Applicant : Kejun Zeng
Filed : October 6, 2003
TC/A.U. : 1725
Examiner : Johnson, Jonathan J
Docket No. : TI-36531
Customer No. : 23494

Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

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Karen Vertz

AMENDMENT-B UNDER 37 C.F.R. 1.111

Dear Sir:

Responsive to the Office action dated October 14, 2005, applicant amends this
application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2
of this paper.

Remarks/Arguments begin on page 3 of this paper.